

## APPROVAL SHEET

CUSTOMER:	
CUSTOMER PART NO	
TYPE NO.: <u>N0Y00L45</u>	
PACKAGE SIZE: <u>3.0mm Round Wide Angle LED La</u>	mps
DICE MATERIAL: GaAsP on GaP	PEAK WAVE LENGTH(nm)587
EMITTED COLOR: Yellow	VIEWING ANGLE (deg): 76
LENS COLOR: Yellow Diffused	_IV(mcd):32

CUSTOMER ENGINEERING DEPARTMENT

### **BRIGHTEK(EUROPE) LIMITED** ENGINEERING DEPARTMENT

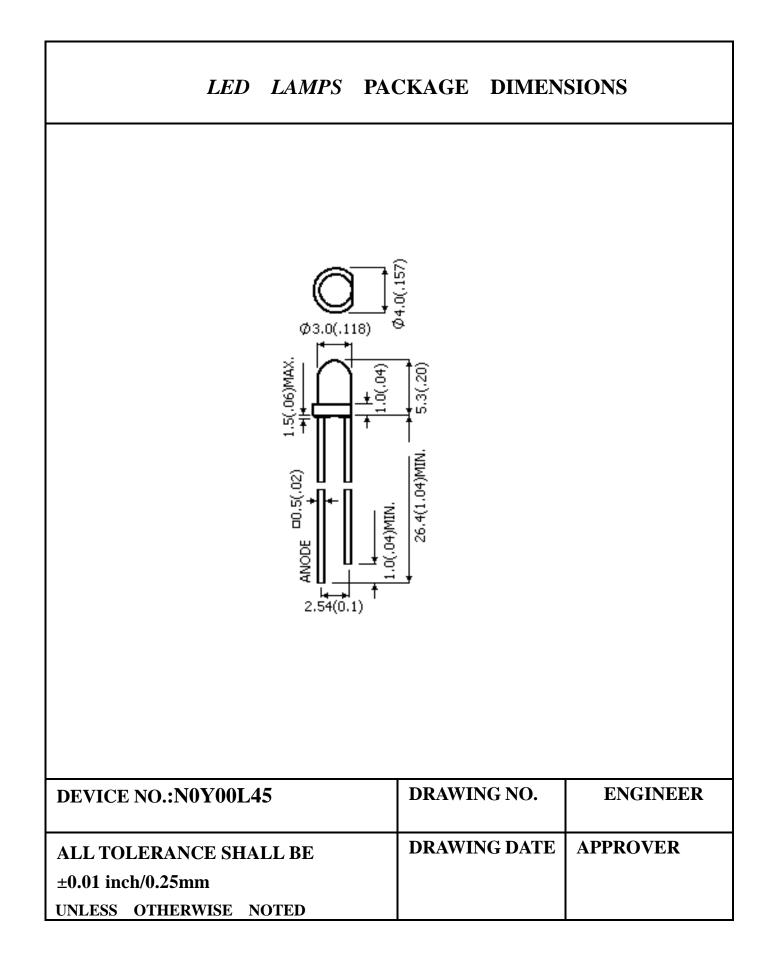
(Authorized Signature)

APPROVED DATE\_\_\_\_\_

ISSUED DATE

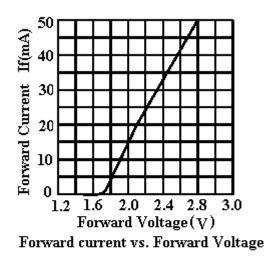
# TYPE NO. : N0Y00L45

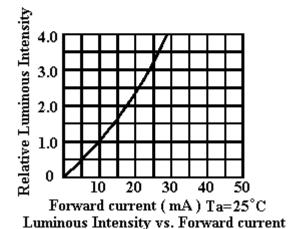
ELECTRICAL / OPTICAL CHARACTERISITICS AT Ta = $25^{\circ}$ C									
PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST			
Luminous Intensity	IV	20	32	45	mcd	IF = 20mA			
Viewing Angle	201/2		76		deg	IF = 20mA			
Peak Emission Wavelength	λp		587		nm				
Dominant Wavelength	λd		590		nm				
Spectral Line Half-Width	Δλ		35		nm				
Forward Voltage	VF	1.7	2.1	2.6	V	IF = 20mA			
Power Dissipation	Pd			85	mW				
Peak Forward Current ( Duty1/10 @ 1KHZ )	IF (Peak)			100	mA				
Recommended Operating Current	IF (Rec)		20		mA				
• ABSOLUTE MAXIMUM RATINGS : $(Ta = 25^{\circ}c)$									
Reverse Voltage			:	5 Volt					
Reverse Current			:	10 uA	( VR=5	5V)			
Operating Tempe	rature Range	•	:	-40°C	TO 85	5°C			
Storage Temperat	ture Range		:	-40°C	TO 100	)°C			
Lead Soldering T [1.6 mm (1/16 in	-	-	:	260°C	For 5 Seco	nds			

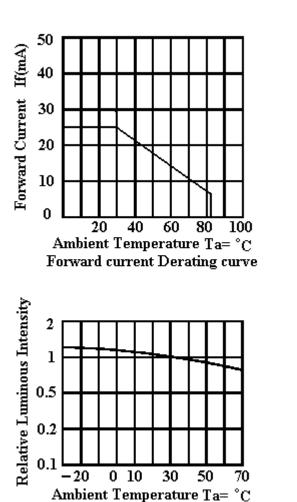


Typical Electro-Optical Characteristics Curves

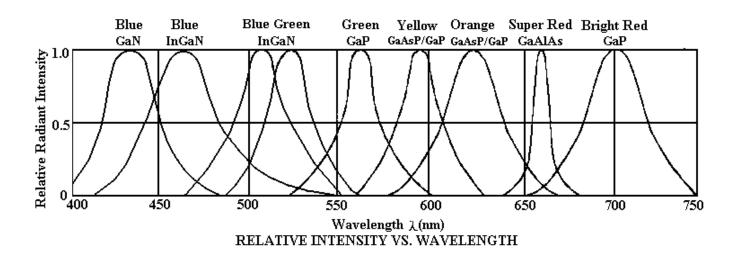
## Yellow (GaAsP/GaP $\lambda P=587nm$ )







Luminous Intensity vs. Ambient Temperature



# **Reliability test For LED Lamps**

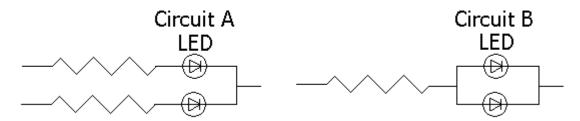
# Type No. : N0Y00L45

NO.	Item	Test Conditions	Test Time/ Cycle	Sample Size	Ac/Re
1	DC Operating Life	Temperature:25℃ IF:20mA	1000HRS	76PCS	0/1
2	High Temperature High Humidity	Temperature:85℃ 85%RH	1000HRS	76PCS	0/1
3	High Temperature Storage	Temperature:100°C	1000HRS	76PCS	0/1
4	Low Temperature Storage	Temperature: -40°C	1000HRS	76PCS	0/1
5	Temperature Cycling	85°C ~ 25°C ~−35°C 15min~ 5min~ 15min	15Cycles	76PCS	0/1
6	Thermal Shock	85°C ~ 25°C ~ − 10°C 5min~ 10sec ~ 5min	15Cycles	76PCS	0/1
7	Solder Heat	Temperature:260°C±5°C	10SEC.	76PCS	0/1

## **Precautions For Use LED**

#### 1. Drive Method

LED is current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in a application, it is recommended that a current limiting resistor be incorporated in the drive circuit.



- (a) Circuit A it is recommended circuit.
- (b) Circuit B the brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

#### 2. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change(Burn out will happen).

#### 3. Storage

The Storage Temperature and RH are:  $5^{\circ}$ C ~  $30^{\circ}$ C, RH 60% or less.

Once the package is opened, the products should be used with in a week. Otherwise,

they should be kept in moisture proof package with moisture absorbent material (silica gel).

we suggest our customers to use our products within a year.

If the moisture absorbent material (silica gel) has faded away or the LEDs exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment: more than 24 hours at  $60^{\circ}$ C  $\pm 5^{\circ}$ C.

## 4. Electrostatic Discharge (ESD)

Static electricity or surge voltage will damage the LEDs Suggestions to prevent ESD damage:

Use of a conductive wrist band or ante-electrostatic glove when handing these LEDs

All devices, equipment, and machinery must be properly grounded.

Work tables storage racks, etc. should be properly grounded

In the events of manual working in process, make sure the devices are well protected from ESD at any time.

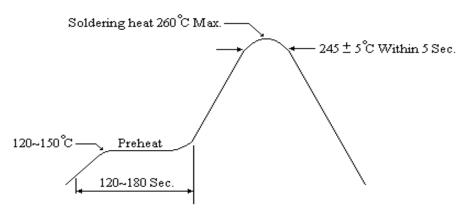
## 5. Others

- (a) If want to have the uniform luminance and color, please use the same binning number, and avoid using intermix to cause the differences of luminance and color.
- (b) The appearance and specifications of the product may be modified for improvement without prior notice.

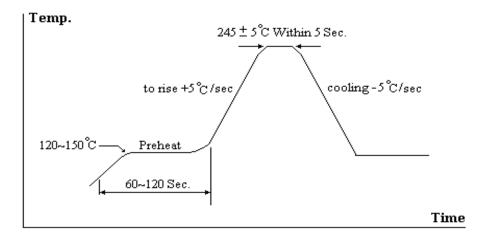
#### 6. Soldering

Recommended soldering condition as shown below:

Soldering heat (DIP)



## **Reflow Temp./Time**



## **Soldering Iron**

Temperature at tip of iron :  $300^{\circ}$ C Max. ( 25 W Max. ) Soldering Time : 3 sec.  $\pm$  1 sec.( one time only ) If temperature is higher, time should be shorter